	Туре	L #	Hits	Search Text	DBs	Time Stamp
1	IS&R	L1	425	(438/782).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 10:33
2	IS&R	L14	407	(414/936).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 11:42
3	IS&Ř	L15	908	(420/107) CCTC	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 12:04
4	IS&R	L16	1023	(414/217) .CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 12:11
5	IS&R	L17	716	(414/937).CCLS.		2004/03/16 12:31

	Туре	L #	Hits	Search	Text	DBs	Time Stamp
6	IS&R	L18	311	(414/938).CCLS.		USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 12:37
7	IS&R	L19	728	(414/940).CCLS.		USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 13:31
8	IS&R	L23	848	(414/935).CCLS.		USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:17
9	IS&R	L24	467	(414/941).CCLS.		USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:43
10	BRS	L25	162154 3	pallet or carri	er or holder	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16

ò

	Туре	L#	Hits	Search Text	DBs	Time Stamp
11	BRS	L26		process or processing or chamber	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:53
12	BRS		•	substrate or substrates or wafer or wafers	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:53
13	BRS	L28	680013 9	mov\$6 or transport\$6 or carry\$6 or transfer\$6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:54
14	BRS	L29	15975	28 near8 27 near8 25	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:56
15	BRS	L30	6425	29 same 26	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:58

. •

	Туре	L #	Hits	Search Text	DBs	Time Stamp
16	BRS	L31	570625 3	align\$6 or position\$6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:58
17	BRS	L32	2391	30 same 31	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 14:59
18	BRS	L33	556	32 and recess\$6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/03/16 15:00

٠,